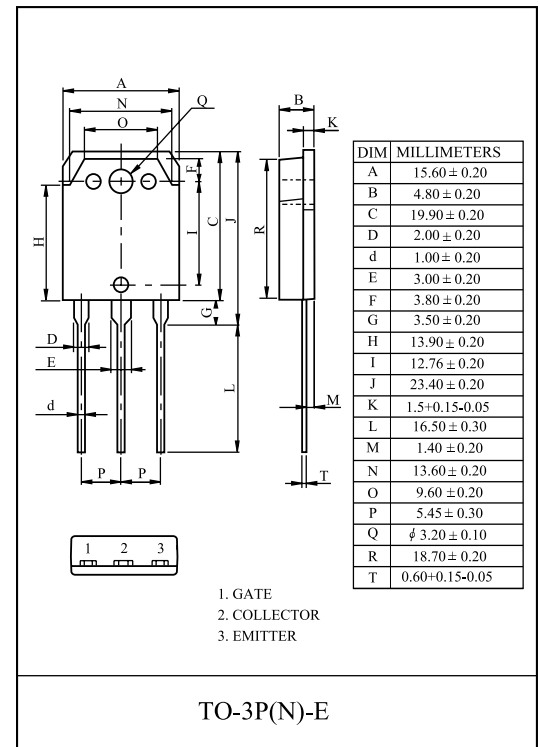


General Description

KEC Field Stop Trench IGBTs offer low switching losses, high energy efficiency and high avalanche ruggedness for soft switching application such as IH(induction heating), microwave oven, etc.

FEATURES

- High speed switching
- High ruggedness, temperature stable behavior
- Soft current turn-off waveforms
- Extremely enhanced avalanche capability



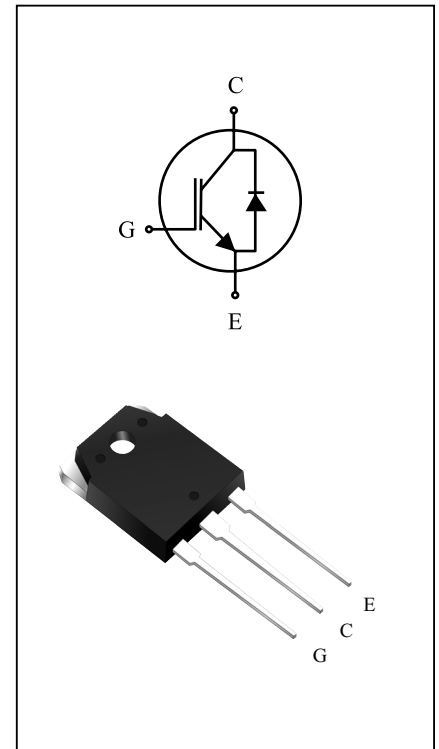
MAXIMUM RATING (Ta=25 °C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Emitter Voltage	V _{CES}	1350	V
Gate-Emitter Voltage	V _{GES}	± 20	V
Collector Current	I _C	@Tc=25 °C	50 A
		@Tc=100 °C	25 A
Pulsed Collector Current	I _{CM} *	75	A
Diode Continuous Forward Current	I _F	25	A
Diode Maximum Forward Current	I _{FM}	75	A
Maximum Power Dissipation	P _D	@Tc=25 °C	250 W
		@Tc=100 °C	100 W
Maximum Junction Temperature	T _j	150	°C
Storage Temperature Range	T _{stg}	-55 to + 150	°C

*Repetitive rating : Pulse width limited by max. junction temperature

THERMAL CHARACTERISTIC

CHARACTERISTIC	SYMBOL	MAX.	UNIT
Thermal Resistance, Junction to Case (IGBT)	R _{thJC}	0.5	°C/W
Thermal Resistance, Junction to Case (DIODE)	R _{thJC}	2.0	°C/W
Thermal Resistance, Junction to Ambient	R _{thJA}	40	°C/W

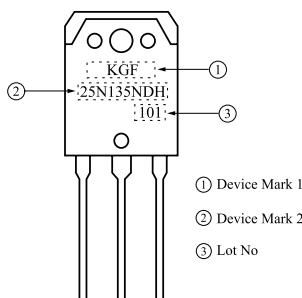


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ELECTRICAL CHARACTERISTICS (Ta=25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT	
Static							
Collector-Emitter Breakdown Voltage	BV_{CES}	$V_{GE}=0V, I_C=1mA$	1350	-	-	V	
Collector Cut-off Current	I_{CES}	$V_{GE}=0V, V_{CE}=1350V$	-	-	1.0	mA	
Gate Leakage Current	I_{GES}	$V_{CE}=0V, V_{GE}=\pm 20V$	-	-	± 100	nA	
Gate Threshold Voltage	$V_{GE(th)}$	$V_{GE}=V_{CE}, I_C=25mA$	5.0	6.0	7.5	V	
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	$V_{GE}=15V, I_C=20A$	-	1.7	-	V	
		$V_{GE}=15V, I_C=25A$	-	1.8	2.1	V	
		$V_{GE}=15V, I_C=25A, T_C = 125^\circ C$	-	1.95	-	V	
		$V_{GE}=15V, I_C=50A$	-	2.2	-	V	
Dynamic							
Total Gate Charge	Q_g	$V_{CC}=600V, V_{GE}=15V, I_C=25A$	-	280	-	nC	
Gate-Emitter Charge	Q_{ge}		-	35	-	nC	
Gate-Collector Charge	Q_{gc}		-	145	-	nC	
Turn-On Delay Time	$t_{d(on)}$	$V_{CC}=600V, I_C=25A, V_{GE}=15V, R_G=10\Omega$ Inductive Load, $T_C = 25^\circ C$	-	50	-	ns	
Rise Time	t_r		-	20	-	ns	
Turn-Off Delay Time	$t_{d(off)}$		-	320	-	ns	
Fall Time	t_f		-	110	-	ns	
Turn-On Switching Loss	E_{on}		-	3.6	-	mJ	
Turn-Off Switching Loss	E_{off}		-	1.1	-	mJ	
Total Switching Loss	E_{ts}		-	4.7	-	mJ	
Turn-On Delay Time	$t_{d(on)}$		$V_{CC}=600V, I_C=25A, V_{GE}=15V, R_G=10\Omega$ Inductive Load, $T_C = 125^\circ C$	-	55	-	ns
Rise Time	t_r			-	25	-	ns
Turn-Off Delay Time	$t_{d(off)}$			-	335	-	ns
Fall Time	t_f	-		220	-	ns	
Turn-On Switching Loss	E_{on}	-		3.7	-	mJ	
Turn-Off Switching Loss	E_{off}	-		2.0	-	mJ	
Total Switching Loss	E_{ts}	-		5.7	-	mJ	
Input Capacitance	C_{ies}	$V_{CE}=30V, V_{GE}=0V, f=1MHz$	-	4300	-	pF	
Output Capacitance	C_{oes}		-	110	-	pF	
Reverse Transfer Capacitance	C_{res}		-	75	-	pF	

Marking



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ELECTRICAL CHARACTERISTIC OF DIODE

CHARACTERISTIC	SYMBOL	TEST CONDITION		MIN.	TYP.	MAX.	UNIT
Diode Forward Voltage	V_F	$I_F = 25A$	$T_C = 25^\circ C$	-	1.9	2.5	V
			$T_C = 125^\circ C$	-	2.0	-	
Diode Reverse Recovery Time	t_{rr}		$T_C = 25^\circ C$	-	220	290	ns
			$T_C = 125^\circ C$	-	250	-	
Diode Peak Reverse Recovery Current	I_{rr}	$I_F = 25A$ $di/dt = 200A/\mu s$	$T_C = 25^\circ C$	-	30	39	A
			$T_C = 125^\circ C$	-	39	-	
Diode Reverse Recovery Charge	Q_{rr}		$T_C = 25^\circ C$	-	3400	4420	nC
			$T_C = 125^\circ C$	-	4900	-	

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Fig 1. Saturation Voltage Characteristics

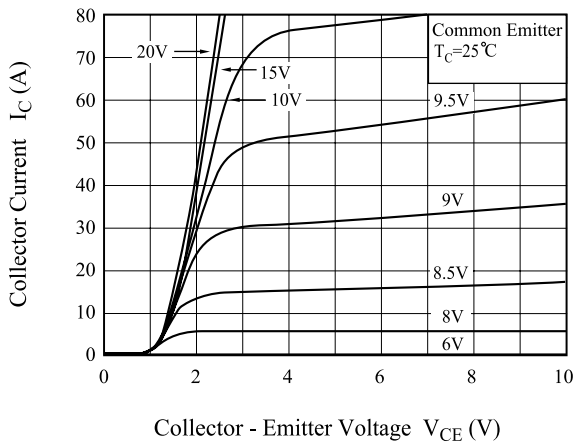


Fig 2. Saturation Voltage Characteristics

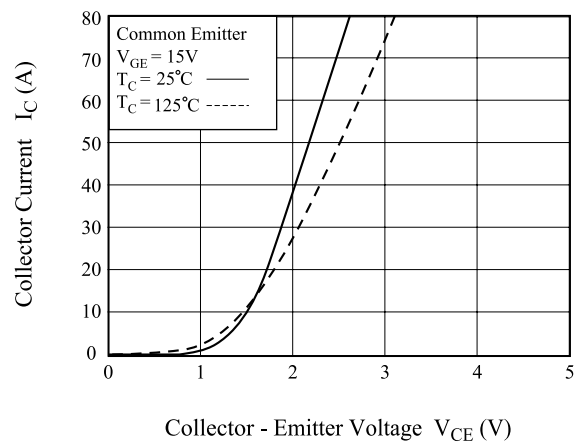


Fig 3. Saturation Voltage vs. Case Temperature

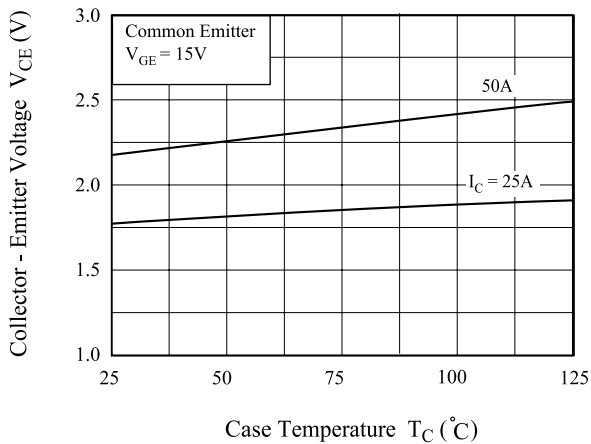


Fig 4. Saturation Voltage vs. V_{GE}

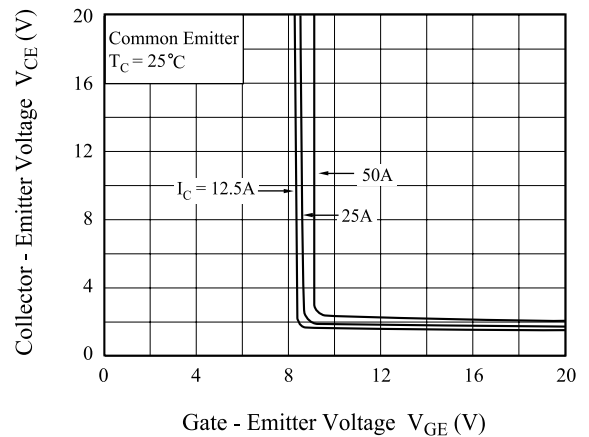


Fig 5. Saturation Voltage vs. V_{GE}

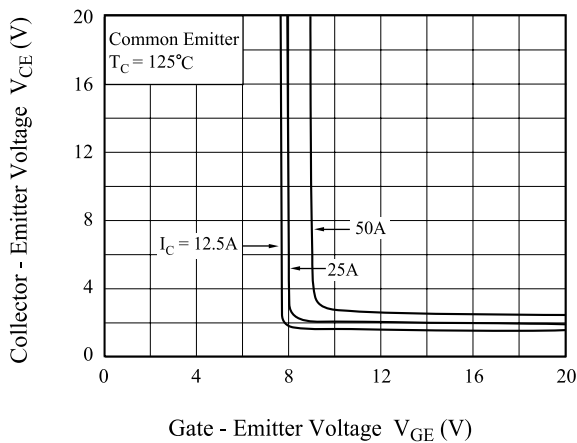
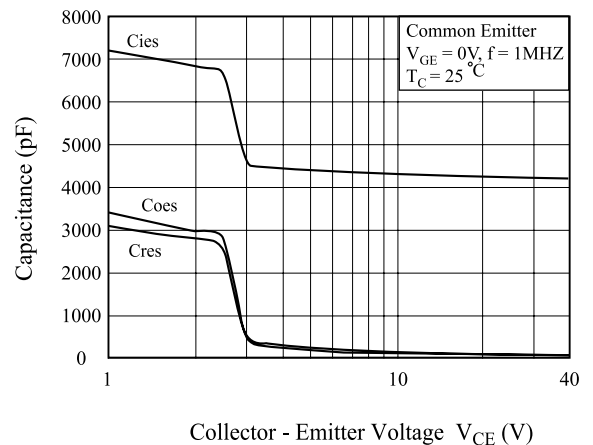


Fig 6. Capacitance Characteristics



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Fig 7. Turn-On Characteristics vs. Gate Resistance

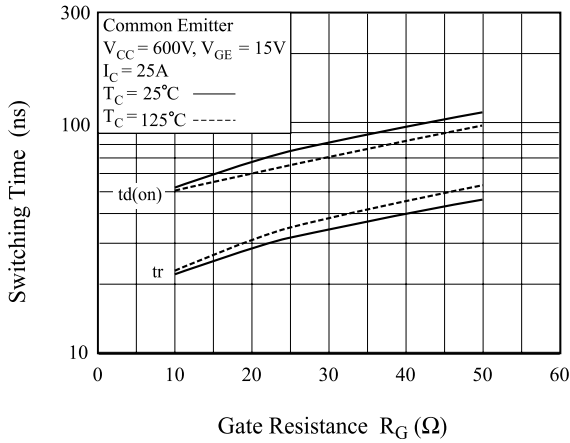


Fig 8. Turn-Off Characteristics vs. Gate Resistance

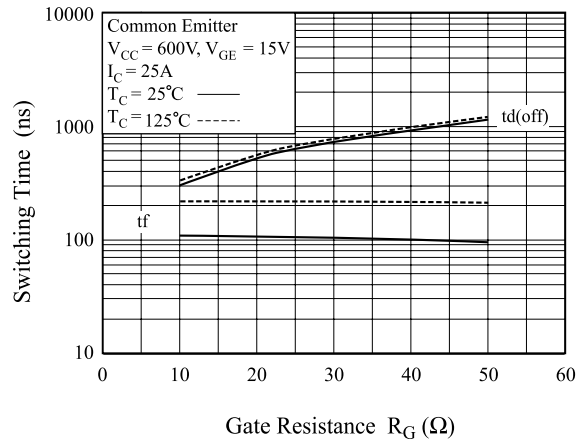


Fig 9. Switching Loss vs. Gate Resistance

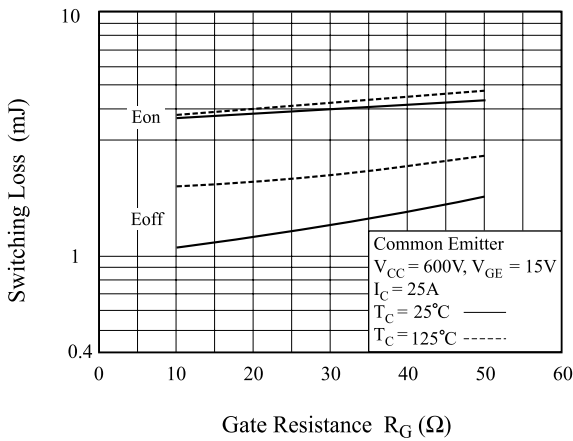


Fig 10. Turn-On Characteristics vs. Collector Current

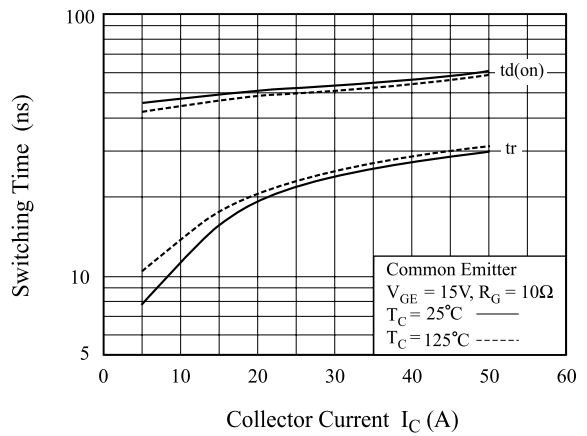


Fig 11. Turn-Off Characteristics vs. Collector Current

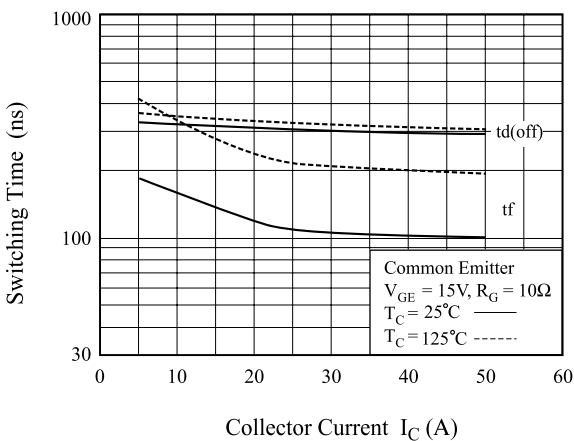
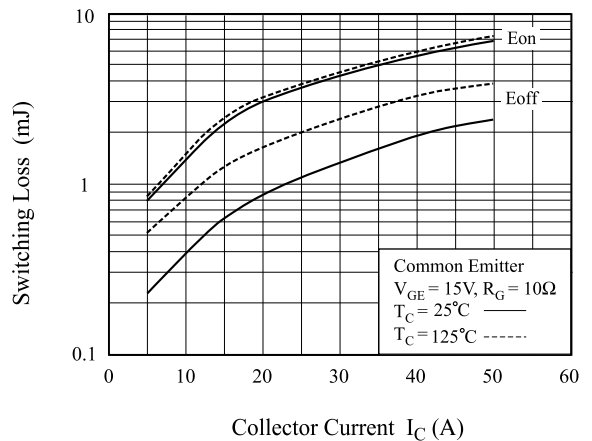


Fig 12. Switching Loss vs. Collector Current



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Fig 13. Gate Charge Characteristics

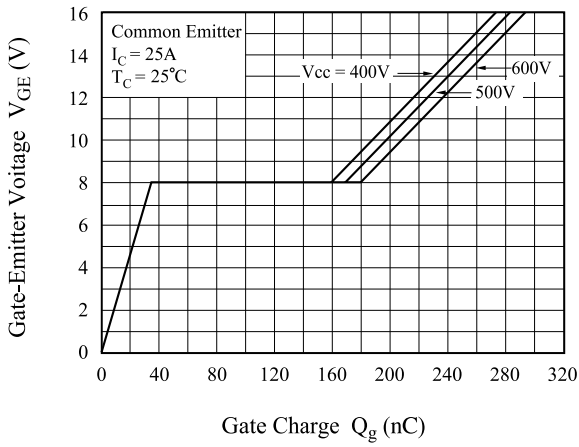


Fig 14. SOA Characteristics

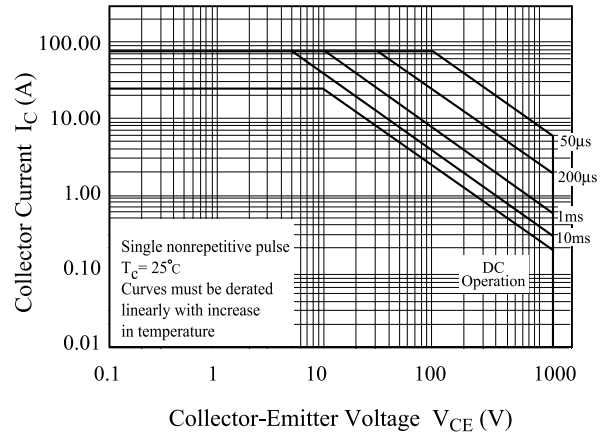


Fig 15. Turn-Off SOA

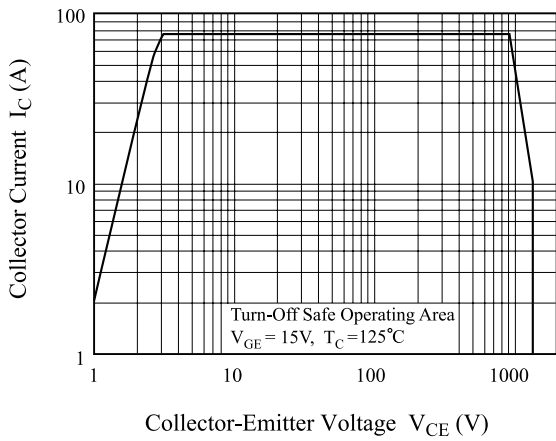
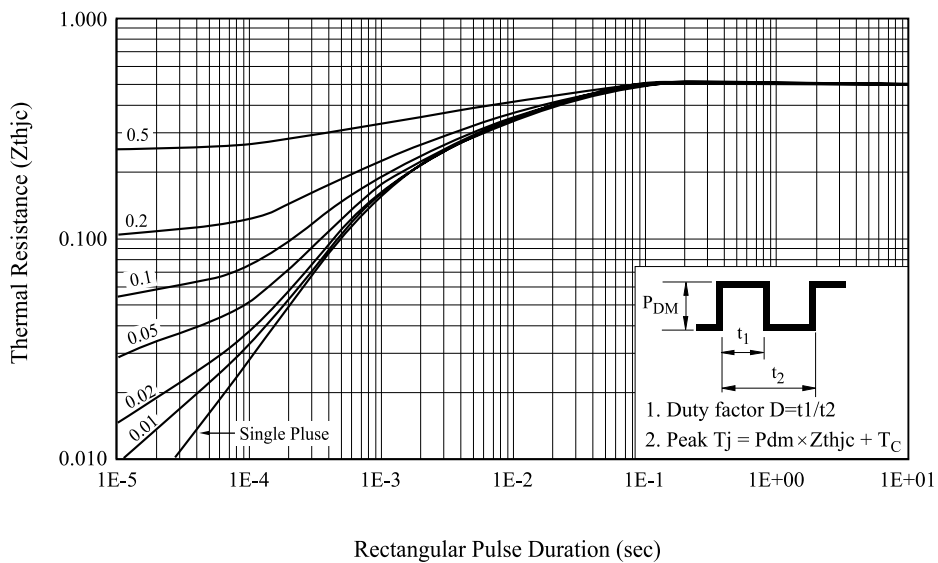


Fig 16. Transient Thermal Impedance of IGBT



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Fig 17. Forward Characteristics

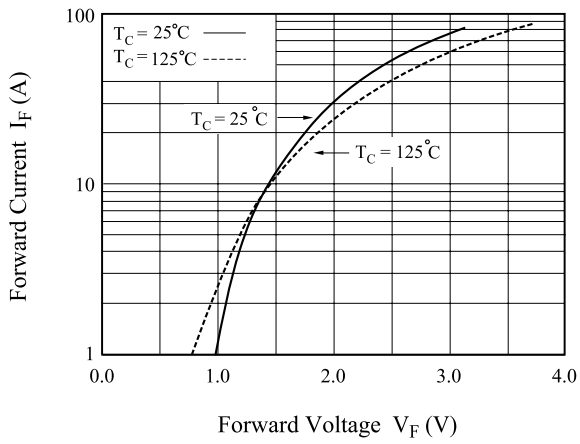


Fig 18. Reverse Recovery Current

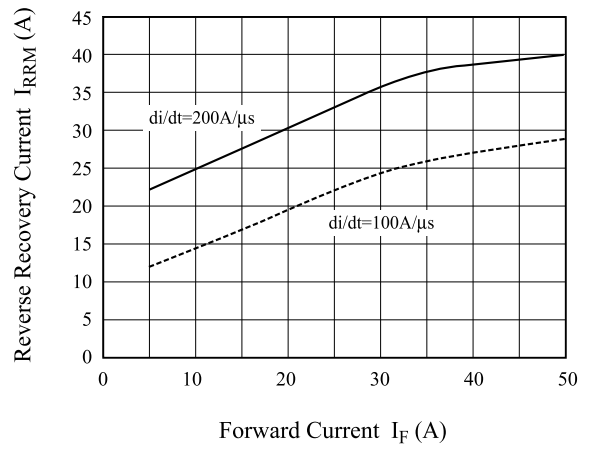
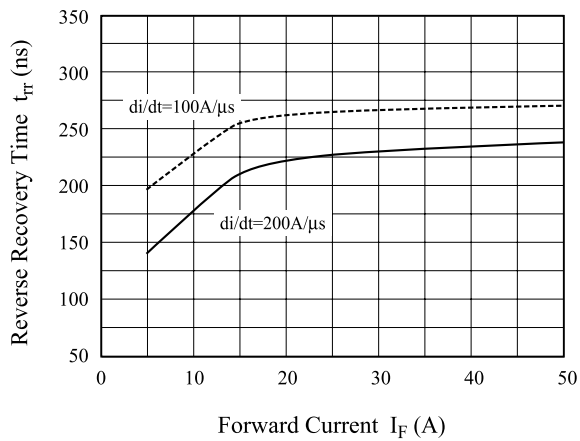


Fig 19. Reverse Recovery Time



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Fig 20. Switching Test Circuit

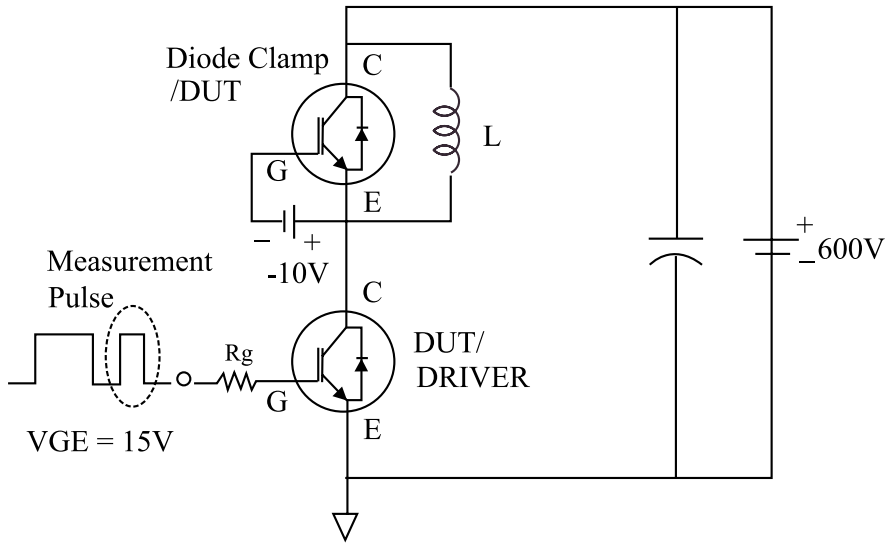


Fig 21. Definition Switching Time & Loss

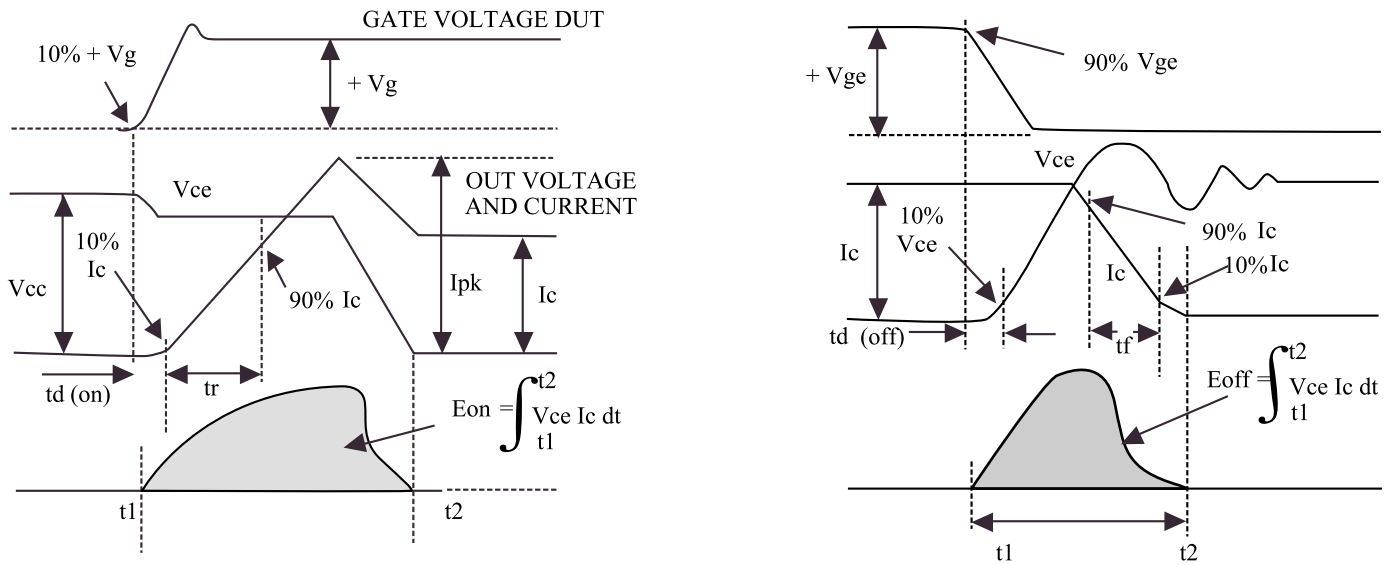


Fig 22. Definition Diode Switching Time

